

L Number	Hits	Search Text	DB	Time stamp
-	0	("heatherwithlong.xa.").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/16 13:29
-	4	(heather with long).xa.	USPAT	2004/05/27 13:17
-	361	(camera or ccd) with metal with plate and @ad<=20000128	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/27 13:27
-	1	09/769455	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/27 13:42
-	19	metal with plate with open\$3 with (ccd or camera) and @ad<=20000128	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/27 15:22
-	0	bit\$2plane with sensor\$2bit	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/27 15:22
-	2	pixel\$2bit with sensor\$2bit	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/27 15:24
-	0	pixel\$2bit with bitplane	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/27 15:24
-	0	pixel\$2bit and bitplane	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/27 15:24
-	1	pixel\$2bit and bit\$2plane	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/27 16:11
-	1	09/771580	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/27 16:12
-	1	09/772662	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/27 16:12
-	47	ccd with adhesive with plate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/14 11:06
-	42	ccd with adhesive with plate and @ad<=20001231	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/14 13:33
-	602	(circuit or board or print\$3) with plate with ccd	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/14 13:34

-	24	(circuit or board or print\$3) with metal with plate with ccd	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/14 14:14
-	2	6308892.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/14 14:14
-	1	(masaharu with taku).in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 13:34
-	1	(taku with masaharu).in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 13:55
-	6	metal with plate with (open\$3 or hole) with ccd	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:05
-	16	(tomio with nagai).in. and toshiba.as.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:13
-	1276	matsumoto.in. and sony.as.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:13
-	2	jp with "57002573"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:29
-	452	348/335.cc1s.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:29
-	0	348/335,340,374,375,45,65 and (plate with open\$3 with ccd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:30
-	7	348/335,340,374,375,45,65.cc1s. and (plate with open\$3 with ccd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:47
-	220	348/374.cc1s.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 15:26
-	0	("5087964,4630095,4594613").PN.	USPAT	2004/06/16 15:27
-	0	5087964,4630095.pn.	USPAT	2004/06/16 15:28
-	0	5087964.pn. and 4630095.pn.	USPAT	2004/06/16 15:28
-	1	5087964.pn.	USPAT	2004/06/16 15:28
-	1	("5087964").PN.	USPAT	2004/06/16 15:30
-	0	("5087964,4630095,4594613,5596229").PN.	USPAT	2004/06/16 15:31
-	0	5087964,4630095,4594613,5596229.pn.	USPAT	2004/06/16 15:31
-	0	(5087964,4630095,4594613,5596229).pn.	USPAT	2004/06/16 15:31

-	11	((("5087964") or ("4630095") or ("4594613") or ("5596229") or ("5072283") or ("5550398") or ("5150180") or ("4803557") or ("4990719") or ("5563067") or ("5731834")).PN.	USPAT	2004/06/16 17:21
-	0	JP-10186188-A.DID. and (adhesive or glue or paste)	USPAT	2004/06/16 17:22
-	4	((("5087964") or ("4630095") or ("4594613") or ("5596229") or ("5072283") or ("5550398") or ("5150180") or ("4803557") or ("4990719") or ("5563067") or ("5731834")).PN.) and (adhesive or glue or paste)	USPAT	2004/06/16 17:22
-	214	257/\$.ccls. and (hous\$3 with (pixel or (imag\$3 with sens\$3)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/18 10:55
-	114	257/\$.ccls. and (hous\$3 with (pixel or (imag\$3 with sens\$3))) and @ad<=20000128	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/18 12:17
-	8	("4803557" "5221964" "5483284" "5596229" "5781807" "5861654" "5946404" "6351288").PN.	USPAT	2004/06/18 11:28
-	534	348/373,374.cccls. and @ad<=20000128	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/18 12:37
-	1	(metal with jig) and 348/373,374.cccls. and @ad<=20001028	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/18 12:46
-	22235	(pcb or (circuit with board)) with open\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/18 12:47
-	2179	(pcb or (circuit with board)) near2 open\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/18 12:47
-	4	((pcb or (circuit with board)) near2 open\$3) with ccd	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/18 12:48
-	154	257/711.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/21 10:58
-	3	257/711.cccls. and ((mount\$3 with plate) with adhesive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/21 15:47
-	24	adhesive with (image with sensor) with open\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/21 15:50
-	51	plate with open\$3 with adhesive and ((image adj sensor) or ccd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/21 15:52

-	2	348/45,65.ccls. and adhesive with open\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 13:55
-	454	348/45,65.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:02
-	24	348/45,65.ccls. and adhesive and @ad<=20001231	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:13
-	1	09/827942	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:48
-	0	ep0773673a1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:49
-	875	257/433.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:50
-	0	ep with 0773673a1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:51
-	0	ep with "0773673"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:51
-	3	"0773673"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:52
-	2	ep with "773673"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:57
-	2	6122009.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:57
-	1222	250/239.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:09
-	142	250/239.ccls. and adhesive and @ad<=20001231	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:10
-	128	250/239.ccls. and adhesive and @ad<=20000128	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 16:33

-	306729	(CCD or (charge adj1 coupled) or imager or (imag\$3 adj1 (sens\$3 or pick\$1up or device or array or apparatus)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:33
-	226266	(metal) near2 (shield\$3 or plate\$1 or hold\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:34
-	5402058	open\$3 or aperture or hole	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:34
-	3077841	corner or edge or lip or projection	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:35
-	3504849	adhesive or glue or resin or epoxy or polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:35
-	1611	((CCD or (charge adj1 coupled) or imager or (imag\$3 adj1 (sens\$3 or pick\$1up or device or array or apparatus))) and ((metal) near2 (shield\$3 or plate\$1 or hold\$3)) and (open\$3 or aperture or hole) and (corner or edge or lip or projection) and (adhesive or glue or resin or epoxy or polymer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:41
-	30086	((metal) near2 (shield\$3 or plate\$1 or hold\$3)) with (open\$3 or aperture or hole)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:37
-	5802	((((metal) near2 (shield\$3 or plate\$1 or hold\$3)) with (open\$3 or aperture or hole)) same (corner or edge or lip or projection))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:38
-	38	((CCD or (charge adj1 coupled) or imager or (imag\$3 adj1 (sens\$3 or pick\$1up or device or array or apparatus))) and (adhesive or glue or resin or epoxy or polymer) and (((((metal) near2 (shield\$3 or plate\$1 or hold\$3)) with (open\$3 or aperture or hole)) same (corner or edge or lip or projection)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:41
-	102	((CCD or (charge adj1 coupled) or imager or (imag\$3 adj1 (sens\$3 or pick\$1up or device or array or apparatus))) same ((metal) near2 (shield\$3 or plate\$1 or hold\$3)) same (adhesive or glue or resin or epoxy or polymer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:56
-	5	((CCD or (charge adj1 coupled) or imager or (imag\$3 adj1 (sens\$3 or pick\$1up or device or array or apparatus))) same ((metal) near2 (shield\$3 or plate\$1 or hold\$3)) same (open\$3 or aperture or hole) same (corner or edge or lip or projection) same (adhesive or glue or resin or epoxy or polymer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:44
-	2993188	pack\$7 or hous\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:57

-	8	((CCD or (charge adj1 coupled) or imager or (imag\$3 adj1 (sens\$3 or pick\$1up or device or array or apparatus))) with (mount\$3) with (pack\$7 or hous\$3) with ((metal) near2 (shield\$3 or plate\$1 or hold\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 16:00
-	10408	((CCD or (charge adj1 coupled) or imager or (imag\$3 adj1 (sens\$3 or pick\$1up or device or array or apparatus))) with (pack\$7 or hous\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 16:00
-	18	((((CCD or (charge adj1 coupled) or imager or (imag\$3 adj1 (sens\$3 or pick\$1up or device or array or apparatus))) with (pack\$7 or hous\$3)) same ((metal) near2 (shield\$3 or plate\$1 or hold\$3)) same (mount\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 16:02
-	17	ccd with opening with adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 09:08
-	2	5952714.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 09:10
-	2	"6693674"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:33
-	1	09/769455	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 11:51
-	390	(ultraviolet with cur\$3 with adhesive) and visco\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 11:52
-	250	(ultraviolet with cur\$3 with adhesive) and visco\$3 and @ad<=20000101	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 11:53